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IP4041CX25

10-channel integrated filter network with ESD input protection to IEC 61000-4-2 level 4

Rev. 01 — 12 February 2010

Product data sheet

1. Product profile

1.1 General description

The IP4041CX25 is a 10-channel RC low-pass filter array which is designed to provide filtering of undesired RF signals. In addition, the IP4041CX25 incorporates diodes to provide protection to downstream components from ElectroStatic Discharge (ESD) voltages as high as ± 20 kV contact according the IEC 61000-4-2 standard, far exceeding level 4.

The IP4041CX25 is fabricated using monolithic silicon technology and integrates 10 resistors and 20 diodes in a single Wafer-Level Chip-Scale Package (WLCSP). These features make the IP4041CX25 ideal for use in applications requiring the utmost in miniaturization such as mobile phone handsets, cordless telephones and personal digital devices.

1.2 Features and benefits

- Pb-free, RoHS compliant and free of halogen and antimony (Dark Green compliant)
- 10-channel integrated π-type RC filter network
- 200 Ω series resistance; 50 pF (typical) channel capacitance
- Integrated ESD protection withstanding ±20 kV contact discharge, far exceeding IEC 61000-4-2 level 4
- WLCSP with 0.5 mm pitch

1.3 Applications

Reduce ElectroMagnetic Interference (EMI) and Radio Frequency Interference (RFI) and provide downstream ESD protection for:

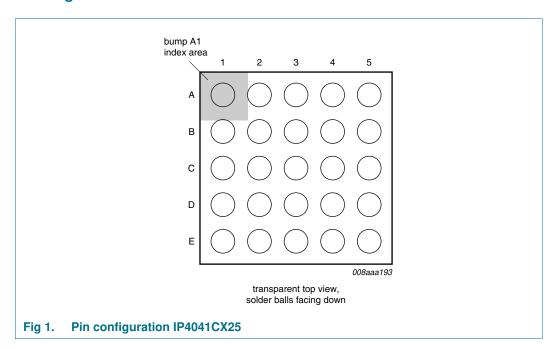
- Cellular and Personal Communication System (PCS) mobile handsets
- Cordless telephones
- Other appliances with low frequency signals (e.g. keypads)
- Wireless data (WAN/LAN) systems and PDAs



10-channel integrated filter network with ESD input protection

2. Pinning information

2.1 Pinning



2.2 Pin description

Table 1. Pinning

| Table 1. I lilling | |
|--------------------|-------------------|
| Pin | Description |
| A1 and E1 | filter channel 1 |
| A2 and E2 | filter channel 2 |
| A3 and E3 | filter channel 3 |
| A4 and E4 | filter channel 4 |
| A5 and E5 | filter channel 5 |
| B1 and D1 | filter channel 6 |
| B2 and D2 | filter channel 7 |
| B3 and D3 | filter channel 8 |
| B4 and D4 | filter channel 9 |
| B5 and D5 | filter channel 10 |
| C1 to C5 | ground |
| | |

3. Ordering information

Table 2. Ordering information

| Type number | Package | | | |
|-------------|---------|--|------------|--|
| | Name | Description | Version | |
| IP4041CX25 | WLCSP25 | wafer level chip-size package; 25 bumps; $2.41 \times 2.41 \times 0.65$ mm | IP4041CX25 | |

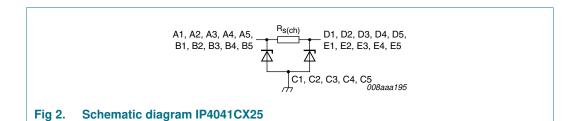
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4. Functional diagram



5. Limiting values

Table 3. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|---------------------------|---------------------------------|---|----------------|------|------|
| V_{I} | input voltage | | -0.5 | +5.5 | V |
| V _{ESD} | electrostatic discharge voltage | all pins to ground | | | |
| | | contact discharge | <u>[1]</u> –20 | +20 | kV |
| | | air discharge | <u>[1]</u> –20 | +20 | kV |
| | | IEC 61000-4-2 level 4; all pins to ground | | | |
| | | contact discharge | -8 | +8 | kV |
| | | air discharge | -15 | +15 | kV |
| P _{ch} | channel power dissipation | continuous power; T _{amb} = 70 °C | - | 50 | mW |
| P _{tot} | total power dissipation | continuous power; T _{amb} = 70 °C | - | 500 | mW |
| T _{stg} | storage temperature | | -55 | +150 | °C |
| T _{reflow(peak)} | peak reflow temperature | 10 s maximum | - | 260 | °C |
| T _{amb} | ambient temperature | | -35 | +85 | °C |

^[1] Device is qualified with 1000 pulses of ±15 kV contact discharges each, according to the IEC 61000-4-2 model and far exceeds the specified level 4 (8 kV contact discharge).

10-channel integrated filter network with ESD input protection

6. Characteristics

Table 4. Channel characteristics

T_{amb} = 25 °C; unless otherwise specified.

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-----------------|---------------------------|---|-----|-----|-----|------|
| $R_{s(ch)}$ | channel series resistance | | 180 | 200 | 220 | Ω |
| C _{ch} | channel capacitance | $V_{bias(DC)} = 0 \text{ V}; f = 1 \text{ MHz}$ | - | 50 | - | pF |
| V_{BR} | breakdown voltage | I _{test} = 1 mA | 6 | - | 15 | V |
| I _{LR} | reverse leakage current | per channel; V _I = 3.0 V | - | - | 25 | nA |

Table 5. Frequency characteristics

T_{amb} = 25 °C; unless otherwise specified.

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|----------------------|-----------------------|---|-----|------------|-----|------|
| α_{il} | insertion loss | $\begin{aligned} R_{gen} &= 50~\Omega;~R_L = 50~\Omega;\\ 800~MHz &< f < 2.4~GHz \end{aligned}$ | 30 | 35 | - | dB |
| α_{ct} | crosstalk attenuation | 800 MHz < f < 6 GHz; R_{gen} = 50 Ω ; R_{L} = 50 Ω | | | | |
| | | adjacent channels; input: A1; output: D1; B1 and E1 terminated by $50~\Omega$ | - | -30 | -20 | dB |
| | | distant channels; input: A1; output: E5; E1 and A5 terminated by $50~\Omega$ | - | -36 | -20 | dB |
| | | 1.0 kHz < f < 800 MHz; $R_{gen} = 50 \Omega$; $R_{L} = 50 \Omega$ | | | | |
| | | adjacent channels; input: A1; output: D1; B1 and E1 terminated by 50 Ω | - | -47 | -30 | dB |
| | | distant channels; input: A1; output: E5; E1 and A5 terminated by 50 Ω | - | -55 | -30 | dB |

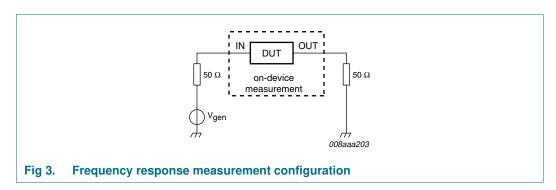
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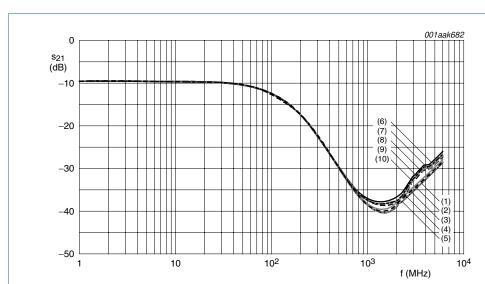
7. Application information

7.1 Insertion loss

The insertion loss measurement configuration of a typical 50 Ω NetWork Analyzer (NWA) system for evaluation of the IP4041CX25 is shown in Figure 3.

The insertion loss of all channels for frequencies up to 6 GHz is displayed in Figure 4.





- (1) Channel 10 (pins B5 and D5).
- (2) Channel 9 (pins B4 and D4).
- (3) Channel 8 (pins B3 and D3).
- (4) Channel 7 (pins B2 and D2).
- (5) Channel 6 (pins B1 and D1).
- (6) Channel 5 (pins A5 and E5).
- (7) Channel 4 (pins A4 and E4).
- (8) Channel 3 (pins A3 and E3).
- (9) Channel 2 (pins A2 and E2).
- (10) Channel 1 (pins A1 and E1).

Fig 4. Measured insertion loss magnitudes

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7.2 Crosstalk

The crosstalk measurement configuration of a typical 50 Ω NWA system for evaluation of the IP4041CX25 is shown in Figure 5.

The measured crosstalk within the IP4041CX25 in a 50 Ω NWA system from one channel to another is shown in Figure 6 for different pairs of channels representing the worst case (channels 1 and 2, channels 6 and 7) and the best case (channels 6 and 10, channels 1 and 5) conditions in terms of physical distance. In all cases the crosstalk is measured for two pins. One is very close to the input while the other is relatively far away. Unused connections are terminated with 50 Ω to ground.

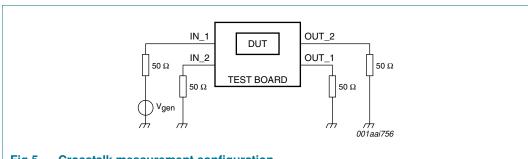
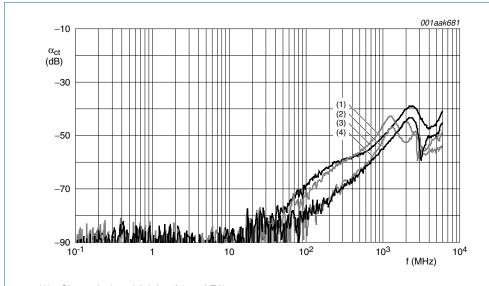


Fig 5. Crosstalk measurement configuration



- (1) Channels 1 and 2 (pins A1 and E2).
- (2) Channels 6 and 10 (pins B1 and D5).
- (3) Channels 6 and 7 (pins B1 and D2).
- (4) Channels 1 and 5 (pins A1 and E5).

Fig 6. Measured crosstalk between adjacent channels

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8. Package outline

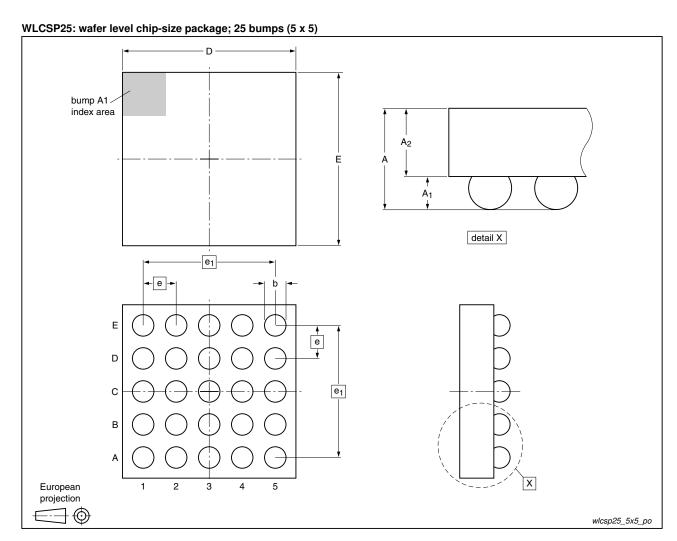


Fig 7. Package outline IP4041CX25 (WLCSP25)

Table 6. Dimensions for Figure 7

| Symbol | Min | Тур | Max | Unit |
|----------------|------|------|------|------|
| A | 0.60 | 0.65 | 0.70 | mm |
| A ₁ | 0.22 | 0.24 | 0.26 | mm |
| A ₂ | 0.38 | 0.41 | 0.44 | mm |
| b | 0.27 | 0.32 | 0.37 | mm |
| D | 2.36 | 2.41 | 2.46 | mm |
| Е | 2.36 | 2.41 | 2.46 | mm |
| е | - | 0.5 | - | mm |
| e ₁ | - | 2.0 | - | mm |

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9. Design and assembly recommendations

9.1 PCB design guidelines

For optimum performance it is recommended to use a Non-Solder Mask PCB Design (NSMD), also known as a copper-defined design, incorporating laser-drilled micro-vias connecting the ground pads to a buried ground-plane layer. This results in the lowest possible ground inductance and provides the best high frequency and ESD performance. For this case, refer to Table 7 for the recommended PCB design parameters.

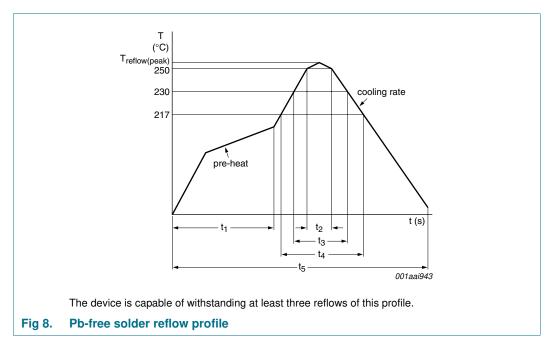
Table 7. Recommended PCB design parameters

| Parameter | Value or specification |
|-------------------------------|------------------------|
| PCB pad diameter | 200 μm |
| Micro-via diameter | 100 μm (0.004 inch) |
| Solder mask aperture diameter | 370 μm |
| Copper thickness | 20 μm to 40 μm |
| Copper finish | AuNi |
| PCB material | FR4 |

9.2 PCB assembly guidelines for Pb-free soldering

Table 8. Assembly recommendations

| Parameter | Value or specification |
|---------------------------------|---------------------------------------|
| Solder screen aperture diameter | 330 μm |
| Solder screen thickness | 100 μm (0.004 inch) |
| Solder paste: Pb-free | SnAg (3 % to 4 %) Cu (0.5 % to 0.9 %) |
| Solder / flux ratio | 50 / 50 |
| Solder reflow profile | see Figure 8 |



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Table 9. Characteristics

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|--------------------|-------------------------|--------------------------------------|-----|-----|-----|------|
| $T_{reflow(peak)}$ | peak reflow temperature | | 230 | - | 260 | °C |
| t ₁ | time 1 | soak time | 60 | - | 180 | S |
| t ₂ | time 2 | time during T \geq 250 $^{\circ}C$ | - | - | 30 | S |
| t ₃ | time 3 | time during T \geq 230 $^{\circ}C$ | 10 | - | 50 | S |
| t ₄ | time 4 | time during T > 217 °C | 30 | - | 150 | S |
| t ₅ | time 5 | | - | - | 540 | S |
| dT/dt | rate of change of | cooling rate | - | - | -6 | °C/s |
| | temperature | pre-heat | 2.5 | - | 4.0 | °C/s |

10. Abbreviations

Table 10. Abbreviations

| Table 10. Appleviations | |
|-------------------------|-------------------------------------|
| Acronym | Description |
| DUT | Device Under Test |
| EMI | ElectroMagnetic Interference |
| ESD | ElectroStatic Discharge |
| FR4 | Flame Retard 4 |
| LAN | Local Area Network |
| NSMD | Non-Solder Mask PCB Design |
| PCB | Printed-Circuit Board |
| PCS | Personal Communication System |
| RFI | Radio Frequency Interference |
| RoHS | Restriction of Hazardous Substances |
| WAN | Wide Area Network |
| WLCSP | Wafer-Level Chip-Scale Package |

11. Revision history

Table 11. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|--------------|--------------|--------------------|---------------|------------|
| IP4041CX25_1 | 20100212 | Product data sheet | - | - |

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|--------------------------------|-------------------|---|
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